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Attorney Docket No.: 042390P9859

Patent

#8/a
6-4-2
Surler

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Lawrence D. Wong

U.S. Serial No: 09/745,705

Filed: December 21, 2000

For: Structural Reinforcement Of
Highly Porous Low K
Dielectric Films By ILD Posts

Examiner: Vu, Hung K.

Art Unit: 2811

Commissioner for Patents
Washington, D.C. 20231

AMENDMENT AND RESPONSE

Dear Sir:

This is in response to the Office Action mailed February 28, 2002. Applicant respectfully requests the Examiner to enter the following amendments and consider the following remarks.

FIRST CLASS CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Assistant Commissioner of Patents, Washington, D.C. 20231

on May 10, 2002
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